

BUFFER GATE DRIVER INTEGRATED CIRCUIT

Features

- High peak output current
- Negative turn-off bias
- Separate Ron / Roff resistors
- Low supply current
- Under-voltage lockout
- Full time ON capability
- Low propagation delay time
- Gate clamping when no supply
- Automotive qualified

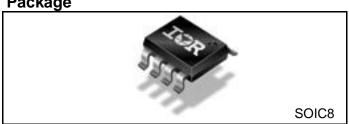
Applications

- High power inverters
- EV/HEV power trains

Product Summary

Outputs Current: +/- 10A Operating Voltage: 13V to 25V **Negative Gate Bias:** 0 to -10V





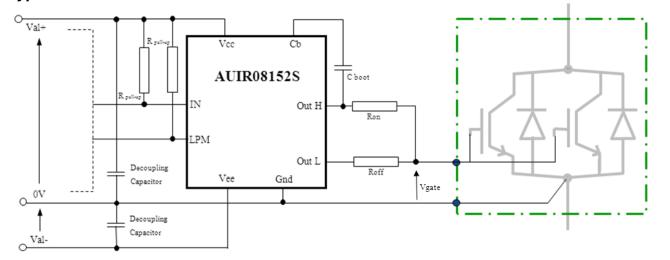
Description

The AUIR08152 buffer brings high power gate drive capability to all pre-driver stages. It is the output extension of the wide I.R gate driver families. It features a negative Gate bias for applications requiring high levels of dv/dt immunity, a low power consumption mode as well as the full time ON gate drive ability. Shoot-through prevention is extended even when the AUIR08152S supplies are absent by mean of a Gate to Emitter self-clamping impedance.

Ordering Information

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Base Part Number	Standard Pack	Complete Part Number					
Dase I art Ivamber	Package Type	Form	Quantity	Complete Part Number			
AUIR08152S	20100	Tube	95	AUIR08152S			
AUIK001323	SOIC8	Tape and reel	2500	AUIR08152STR			

Typical Connection





Absolute Maximum Ratings

Absolute maximum ratings indicate sustained limits beyond which permanent damage to the device may occur. These are stress ratings only, functional operation of the device at these or any other condition beyond those indicated in the "Recommended Operating Condition" is not implied. Exposure to absolute maximum-rated conditions for extended periods may affect device reliability. All voltage parameters are absolute voltages referenced to GND unless otherwise stated in the table. The thermal resistance and power dissipation ratings are measured mounted on board in free air condition.

Symbol	Definition	Min	Max	Units
Vcc-Gnd	Vcc to Gnd maximum voltage	-0.3	+37	
Vcc-Vee	Vcc to Vee maximum voltage	-0.3	+37	
Vcc-VIN	Vcc to Vin maximum voltage	-0.3	+37	V
Vcc-Vlpm	Vcc to VLPM maximum voltage	-0.3	+37	
VCB	CB to OUTH max voltage	-0.3	+5.5	
Ігьм	LPM pin maximum current	-10	+10	Λ
lin	IN pin maximum current	-10	+10	mA mA
VOUTH	OUTH pin maximum voltage, DC operation		V _{CC} + 0.3	V
VOUTL	OUTL pin maximum voltage, DC operation	V _{EE} - 0.2	V _{CC} + 0.3	
IOUTH	Maximum input transient current to OUTH pin (t < 1us,Ron = 2Ω)		2	^
IOUTL	Maximum output transient current from OUTL pin (t < 1us, Roff = 2Ω)		1.5	Α
PD	Package power dissipation @ T _A ≤ 25 °C	_	1	W
RthJA	Thermal resistance, junction to ambient		80	K/W
TJ	Junction temperature	-40	150	_
TS	Storage temperature	-55	150	°C
TL	Lead temperature (soldering, 10 seconds)	_	300	

Recommended Operating Conditions

The recommended conditions represent the AUIR08152 optimum performances for the typical application

Symbol	Definition	Min.	Max.	Units
VCC-GND	Gate driver positive supply voltage	15	25	
GND-VEE	Recommended negative gate bias	0	-10	
VCC-VEE	Total supply voltage	15	35	V
VOUTH	OUTH Output voltage	Vcc - 35	Vcc	
VIN,lpm	IN and LPM pins voltage range	Vcc-35	Vcc	
Cboot	Recommended bootstrap ceramic capacitor	10	47	
Cload	Maximum recommended equivalent gate capacitor	_	240	nF
Cdec	Recommended Vcc & Vee decoupling capacitors*		33	μF
Ron	OUTH series resistor to gate	1.5	20	
Roff	OUTL series resistor to gate	1.5	20	Ω
R pull-up	Recommended pull-up resistor for IN and LPM pins		100	kΩ
PWoff	Minimum recommended OFF time on the IN pin	1	_	
PWon	Minimum recommended ON time on the IN pin	1	_	μs

^{*} Due to the high current application a good quality low ESR capacitor has to be used. Numbers are indicative, a value about 40 times the load capacitance seen at the OutH and OutL pins is suggested.



Static Electrical Characteristics

 V_{CC} – Gnd = 15V, V_{EE}_{-} Gnd = -5V, C_{boot} = 15nF, Ron = Roff = 3Ω , -40 $^{\circ}C$ < T_{A} < 125 $^{\circ}C$ unless otherwise specified.

Symbol	Definition	Min	Тур	Max	Units	Test Conditions
V _{CCUV+}	V _{CC} -GND under-voltage rising edge	_	11.7	12.8		
V _{CCUV} -	V _{CC} -GND under-voltage falling edge	9.6	10.5	_	V	LPM = X, IN = Vcc, Vee = Gnd;
V _{CCUVH}	V _{CC} -GND under-voltage hysteresis	0.5	1.2	_		
VCB _{UV (*)}	VCB under-voltage lockout	2.8	4	5.7		
I_{QGG}	Current out of the Gnd pin	_	20	60		IN = X, LPM = X
I _{QOUTL1}	Current flowing into the OUTL pin	_	0	1.5	μA	IN = Vcc,LPM = X, OUTH = NC, VouTL-Gnd = 15V
I _{QEESW}	V _{EE} pin current, IN cycling	_	3	8		IN = 10kHz - 50% duty cycle LPM = Vcc, C _{LOAD} = 0nF
I _{QEE0}	V _{EE} pin current – output OFF – normal mode	_	1.5	4		IN = Gnd, LPM = Vcc
I _{QEE1}	V _{EE} pin current – output ON – normal mode	_	0.8	1.6		IN = Vcc, LPM = Vcc
I _{QEELQ0}	V _{EE} pin current – output OFF – low power mode		0.6	2.0		IN = Gnd, LPM = Gnd
I _{QEELQ1}	V _{EE} pin current – output ON – low power mode		0.8	1.6	^	IN = Vcc, LPM = Gnd
I _{QEEUV}	V _{EE} pin current at low Vcc supply	_	0.6	1.6	mA	$IN = X$, $LPM = X$, $V_{CC} < V_{CCUV}$.
I _{QB}	CB pin sink current	_	0.5	1		IN = Vcc, LPM = Vcc, Vcb-Vouth = 5.5V
I _{QOUTH0}	OUTH pin sourced current – normal mode		1	3.5		IN = Gnd, LPM = Vcc $OUTH = V_{EE}, OUTL = NC$
I _{QOUTH0LQ}	OUTH pin sourced current – low power mode		0.2	0.5		IN = Gnd, LPM = Gnd $OUTH = V_{EE}, OUTL = NC$
I _{BOUTH}	CB pin sourced current – normal mode	30	90	_		IN = Gnd, LPM = Vcc, OUTL = NC, CB = OUTH = Vee
I _{BOUTH_pl}	CB pin pulsed sourced current – normal mode	90	200	_		Min pulse length 2us guaranteed by design
I _{BOUTHLQ}	CB pin sourced current – low power mode	0.5	5	23		IN = Gnd, LPM = Gnd, OUTL = NC, CB = OUTH = Vee
I _{OUTH+} /I _{OUTL-}	OUTH /OUTL pins output current capability	10	_	_	Α	LPM = X VOUTL-: t < 100us, VOUTH+: CB charged
Vcc-VinH	IN pin – output ON voltage	1.5	2.5	_		
Vcc-VinL	IN pin – output OFF voltage		4.5	5.5		
V _{INhys}	IN pin voltage hysteresis	1	2	_	V	
Vcc-VLPMH	LPM pin normal mode voltage	1.4	2	_	V	Vcc-Gnd > Vccuv+
Vcc-VLPML	LPM pin low power mode voltage	_	3.2	3.8		
V _{LPMhys}	LPM pin voltage hysteresis	0.3	1.1	_		
I _{IN15}	IN pin sourced current	40	90	180		IN = Gnd
I _{LPM15}	LPM pin sourced current	10	25	50	μA	LPM = Gnd
R _{dson OUTH}	OUTH transistor Rdson		100	200		IN = Vcc, lout 10A, t < 100us, Gnd = Vee, VcB = Vouth + 5.5V
R _{dson OUTL}	OUTL transistor Rdson		200	400	mΩ	-IN = Gnd, lout = 10A, t < 100us, Gnd = Vee
I _{PMOS (*)}	OUTH Pulling- up current source	15	30	120	mA	IN = Vcc, LPM = X, Vcc - Vouth = 1.5V
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(*)When VcB – Vouth < VCB_{UV}, OUTH pin remaining pulled-up to Vcc is guaranteed for at least 3usec with low impedance (=Ron) via VDmos then continuously with higher impedance via PMos (= Ipmos, see block diagram).



 $\begin{tabular}{lll} \textbf{Switching Electrical Characteristics} \\ V_{CC}-Gnd=15V, Vee-Gnd=-9V, Cboot=15nF, Ron=Roff=3\Omega\ , C_{LOAD}=220nF, -40\ ^{\circ}C < T_{A} < 125\ ^{\circ}C \ unless \ otherwise \ specified. \\ \end{tabular}$

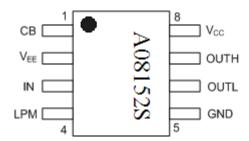
Symbol	Definition	Min.	Тур.	Max.	Units	Test Conditions
t _{on}	OUTH turn on propagation delay	_	150	350		
t _{off}	OUTL turn off propagation delay		230	350		Coo novemetove definitions
t _{off_VCBuv}	OUTL turn off prop. delay when VcB < VCBuv *		90	350		See parameters definitions LPM = X
t _r	OUTH rise time	_	50	150		
t _f	OUTL fall time		50	150	ns	
t_{rLQ}	OUTH rise time (IN=1, Vcc ramping up, LPM = Gnd)		50	250		V _{EE} = LPM = Gnd, IN = Vcc
t_{fLQ}	OUTL fall time (IN=1, Vcc ramping down, LPM = Gnd)		50	250		V _{EE} = LPM = Gnd, IN = Vcc
Min Out-ON	ON time for 0.5µs IN pulse	200	600	900		Cload = open
Min Out-OFF	OFF time for 0.5µs IN pulse, CB discharged	200	500	900		Cload = open, CB = 15 nF
Min _{Out-OFF}	OFF time for 0.5µs IN pulse, CB charged	200	400	900		Cload = open, CB = 15 nF
t _{onLPM}	LPM activation time (from LPM edge to Ics < IBOUTH/2)		0.6	3	116	by design
t _{offLPM}	LPM deactivation time (from LPM edge to IcB > IBOUTH/2)	_	0.6	3	μs	by design

^{*} See also Fig. 5

Truth Table

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IN	LPM	VCC	OUTH	OUTL	Status
Х	Х	< Vccuv	Open	Vee	IGBT or MOSFET = OFF - Low power mode
Gnd	Gnd	> Vccuv	Open	Vee	IGBT or MOSFET = OFF - Low power mode
Gnd	Vcc	> Vccuv	Open	Vee	IGBT or MOSFET = OFF - Normal mode
Vcc	Gnd	> Vccuv	Vcc	Open	IGBT or MOSFET = ON - Low power mode
Vcc	Vcc	> Vccuv	Vcc	Open	IGBT or MOSFET = ON - Normal mode

Lead Assignments



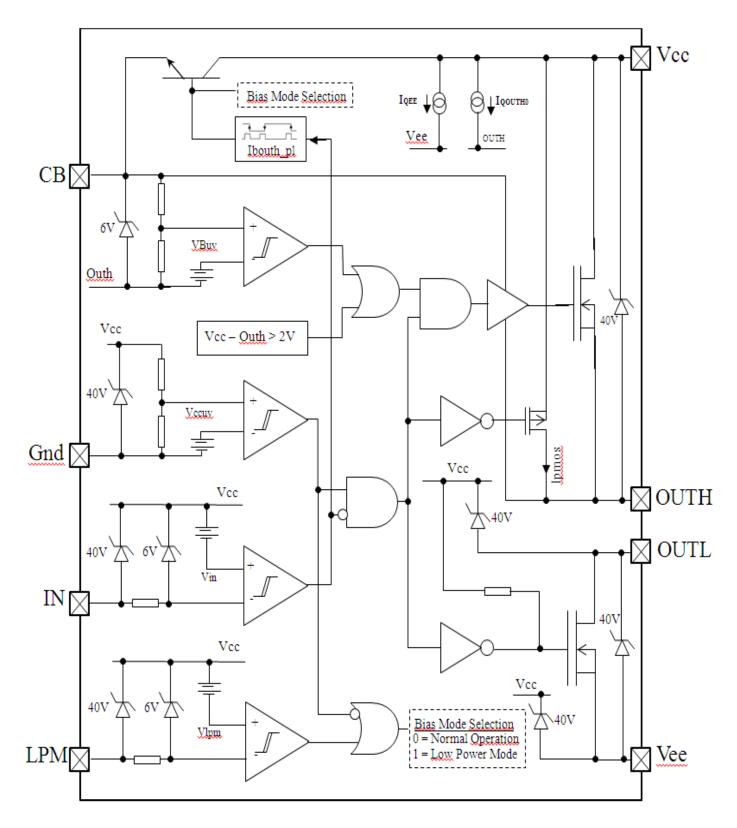
Lead Definitions

Symbol	Description	Pin
СВ	External Bootstrap capacitor (cf. typical connection schematic)	1
Vee	Negative Supply Pin	2
IN	Gate Drive Input, (IN= Vcc forces OutH = high)	3
LPM	Low Power Mode Input, LPM= GND activates the Low Power Mode	4
GND	0V – IGBT Emitter or MOSFET Source Connection (cf. typical connection schematic)	
OUTL	Gate Drive Output Pull down	
OUTH	Gate Drive Output Pull up	
Vcc	Positive Supply Pin	8

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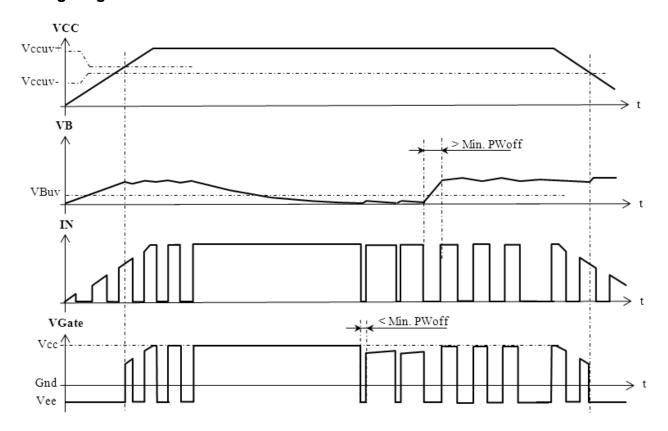


Functional Block Diagram

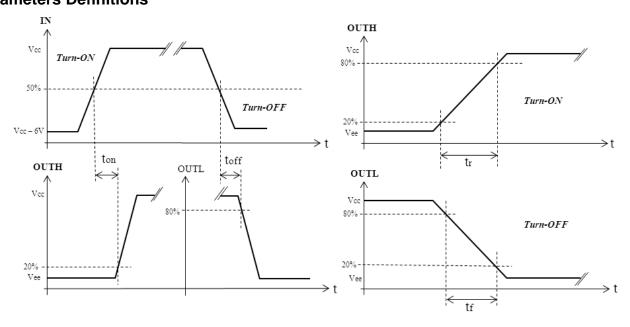




Timing Diagram



Parameters Definitions



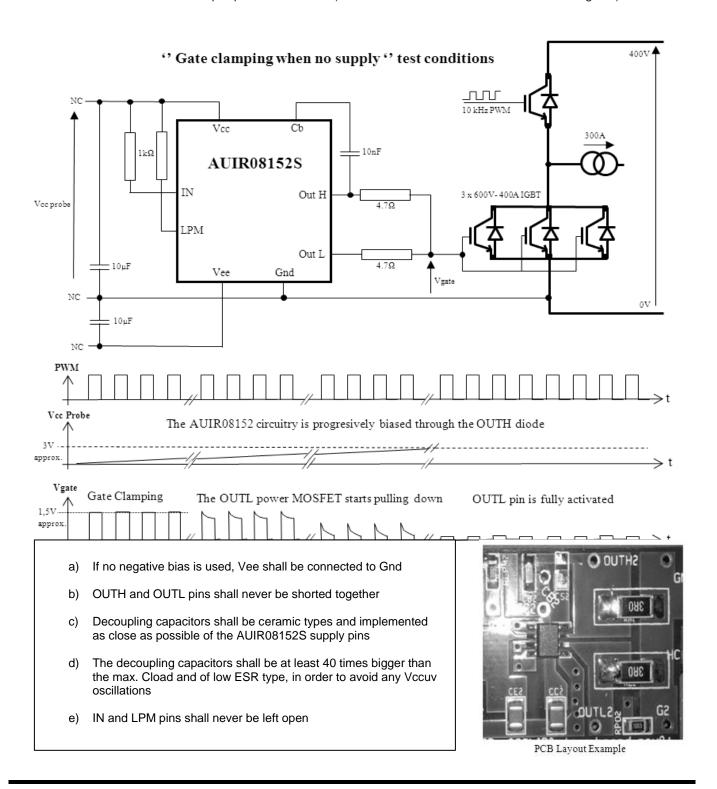
Propagation delay definitions

Rise and fall time definitions



Application Tips

The AUIR08152S features a self-clamping gate protection in case of the auxiliary power supply disappears. A resistor is pulling up the gate of the OUTL internal power MOSFET to keep OutL pulled down until a minimum Vcc is applied, when Vcc disappears (< about 3V) then the Vgate is clamped via the OUTH ESD diode. In this situation forcing OutL high injects current into the pin that charges the Vcc decoupling capacitor and reactivates the internal OUTL output power MOSFET (for more info see the Functional Block Diagram).





Parameters

Figures are given for typical value @ Tj=25°C otherwise specified

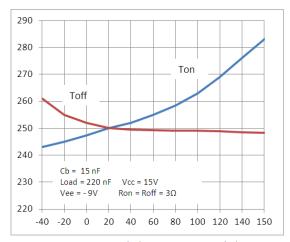


Figure 1: Ton and Toff (ns) Vs Temperature (°C)

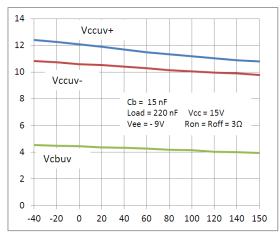


Figure 3: Vccuv+, Vccuv- and Vcbuv (V) Vs Temperature (°C)

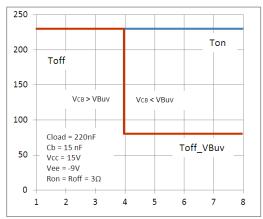


Figure 5: Ton, Toff (ns) Vs IN pulse duration (μs)

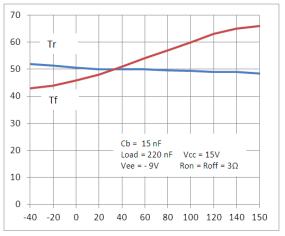


Figure 2: Tr and Tf (ns) Vs Temperature (°C)

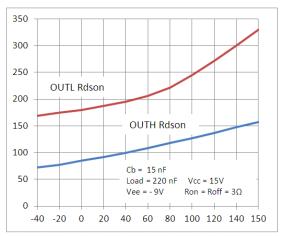


Figure 4: OUTH & OUTL Rdson's Vs Temperature (°C)

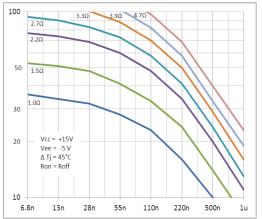
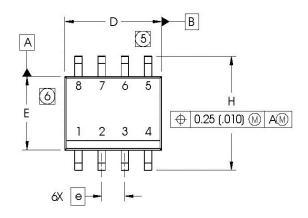


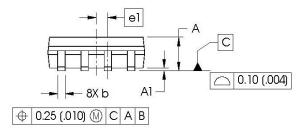
Figure 6: Max PWM Frequency (kHz) Vs Gate Capacitance (F) & Rg (Ω)

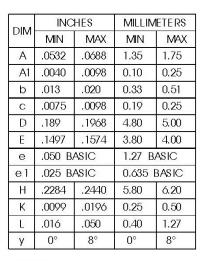


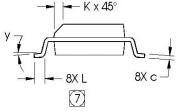
Case Outline - SO8

Dimensions are shown in millimeters (inches)



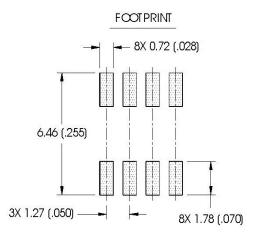






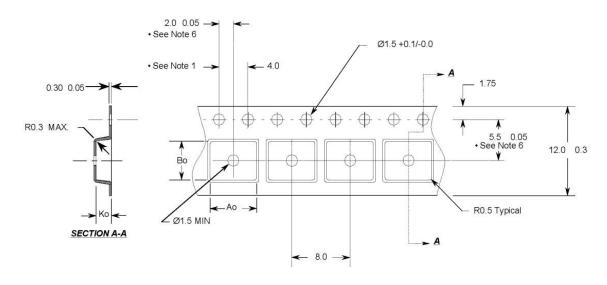
NOTES:

- 1. DIMENSIONING & TOLERANGING PER ASME Y14.5M-1994.
- 2. CONTROLLING DIMENSION: MILLIMETER
- 3. DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).
- 4. OUTLINE CONFORMS TO JEDEC OUTLINE MS-012AA.
- (5) DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.15 (.006).
- (6) DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.25 (.010).
- DIMENSION IS THE LENGTH OF LEAD FOR SOLDERING TO A SUBSTRATE.





Tape & Reel SO8



Notes:

- 10 sprocket hole pitch cumulative tolerance 0.2
- Camber not to exceed 1mm in 100mm
 Material: Black Conductive Advantek Polystyrene
- 4. Ao and Bo measured on a plane 0.3mm above the bottom of the pocket
- 5. Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
- 6. Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole.

Ao = 6.4 mm Bo = 5.2 mm

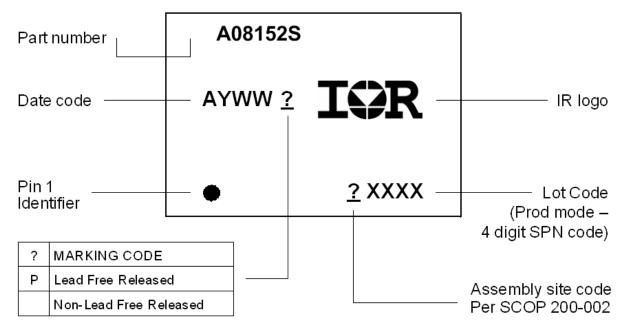
Ko = 2.1 mm

- All Dimensions in Millimeters -

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Part Marking Information



Qualification Information[†]

Qualif	ication Level	Automotive (per AEC-Q100) Comments: This family of ICs has passed an Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.			
Moisture S	ensitivity Level	SOIC8N	MSL2 ^{††} 260°C (per IPC/JEDEC J-STD-020)		
	Machine Model		Class M2 (+/-200V) (per AEC-Q100-003)		
ESD	Human Body Model	Class H2 (+/-2500V) (per AEC-Q100-002)			
	Charged Device Model	Class C4 (Pass +/-1000V) (per AEC-Q100-011)			
IC Lat	ch-Up Test	Class II, Level A (per AEC-Q100-004)			
RoHS	Compliant	Yes			

- † Qualification standards can be found at International Rectifier's web site http://www.irf.com/
- †† Higher MSL ratings may be available for the specific package types listed here.

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Revision History

Revision	Date	Notes/Changes
A1	August 5 th , 2013	Preliminary Datasheet AUIR08152S
A2	August 23 rd 2013	Advanced datasheet
A3	August 26 th 2013	Advanced datasheet
A4	September 2 nd 2013	Final datasheet, updated lout+ and lout- definition
A5	Dec. 5 th , 2013	Updated cosmetic for production
A6	Aug. 27 th , 2014	Updated note * on page 3, updated page footer